

Application No. 10/632,553  
Attorney Docket: CPAC 1017-6 D4

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On 13 January 2004.

Signed: Paul F. Furley

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Marcos Karnezos	Attorney Docket No.: CPAC 1017-6 D4
Application No.: 10/632,553	Examiner: Unassigned
Filed: 02 August 2003	Group: 2812
Title: Semiconductor Multi-Package Module Having Package Stacked Over Die-Down Flip Chip Ball Grid Array Package And Having Wire Bond Interconnect Between Stacked Packages	Confirmation No.: 2573
	<b>Customer No. 22470</b>

**INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

It is requested that the information identified in this statement be considered by the Examiner and made of record in the above-identified application. This statement is not intended to represent that a search has been made or that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 C.F.R. 1.56.

Enclosed with this statement is a Form PTO-1449. The Examiner is requested to initial the form and return it to the undersigned in accordance with M.P.E.P. 609.

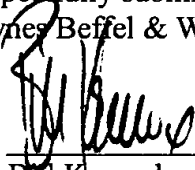
Also enclosed with this statement is a copy of each cited document as required by 37 C.F.R. 1.98. If, however, this application was filed after June 30, 2003, copies of U. S. Patents and U. S. Patent Application Publications are not enclosed. (See O. G. Notice of August 5, 2003.)

This statement should be considered under 37 C.F.R. 1.97(b) because it is being filed before the mailing date of the first Office Action on the merits.

***Fee Authorization.*** The Commissioner is hereby authorized to charge any additional fees or credit any overpayment associated with this communication to Deposit Account No. 50-0869 (CPAC 1017-6 D4). A duplicate copy of this authorization is enclosed.

Respectfully submitted,  
Haynes Beffel & Wolfeld LLP

Date: 13 January 2004

By:  Reg. No. 33,407  
Bill Kennedy, Reg. No. 33,407

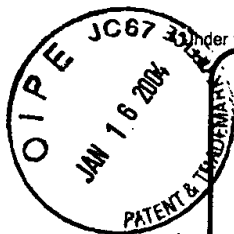
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PTO/SB/08A (08-00)

Approved for use through 10/31/2002. OMB 0651-0031  
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## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(use as many sheets as necessary)

### Complete if Known

Application Number	10/632,553
Filing Date	08/02/03
First Named Inventor	Karnezos
Group Art Unit	2812
Examiner Name	Unassigned
Attorney Docket Number	CPAC 1017-6 D4

Sheet 1 of 1

### U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number	Kind Code <sup>2</sup> (if known)			
	A1	6,274,930		Vaiyapuri et al.	08/14/01	
	A2	6,340,846		LoBianco et al.	01/22/02	
	A3	6,376,904		Haba et al.	04/23/02	
	A4	6,388,313		Lee et al.	05/14/02	
	A5	6,400,007		Wu et al.	06/04/02	
	A6	6,414,381		Takeda	07/02/02	
	A7	6,424,050		Komiyama	07/23/02	
	A8	2002/0004258	A1	Nakayama et al.	01/10/02	
	A9	2002/0014689	A1	Lo et al.	02/07/02	
	A10	2002/0125557	A1	Chen et al.	09/12/02	
	A11	2002/0125558	A1	Akram et al.	09/12/02	
	A12	2002/0130404	A1	Ushijima et al.	09/19/02	
	A13					
	A14					
	A15					
	A16					
	A17					
	A18					
	A19					
	A20					

### FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent Document			Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T <sup>6</sup>
		Office <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup> (if known)				
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<sup>1</sup> Unique citation designation number. <sup>2</sup> See attached Kinds of U.S. Patent Documents. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

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